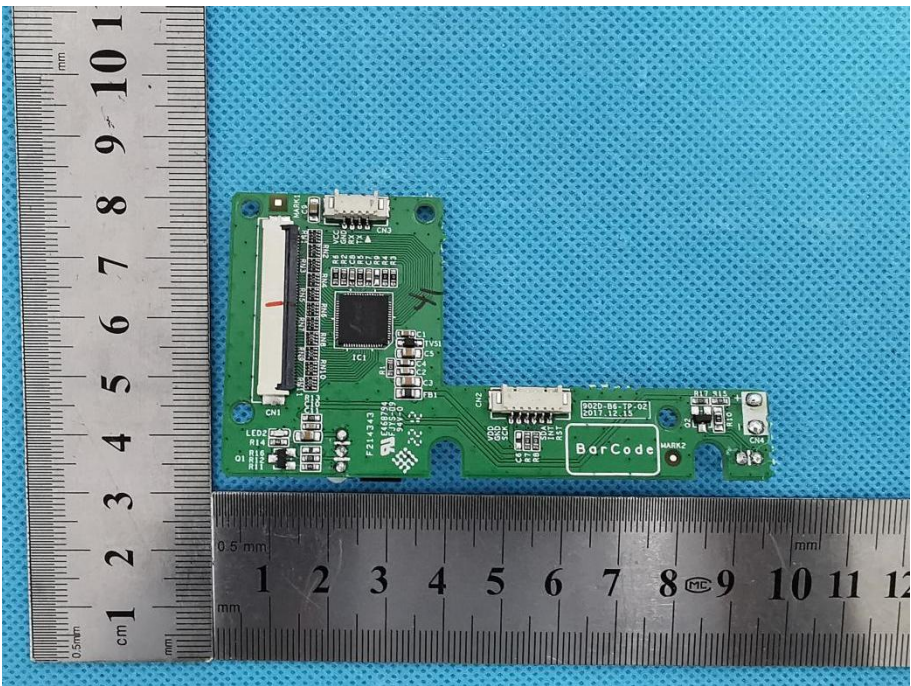
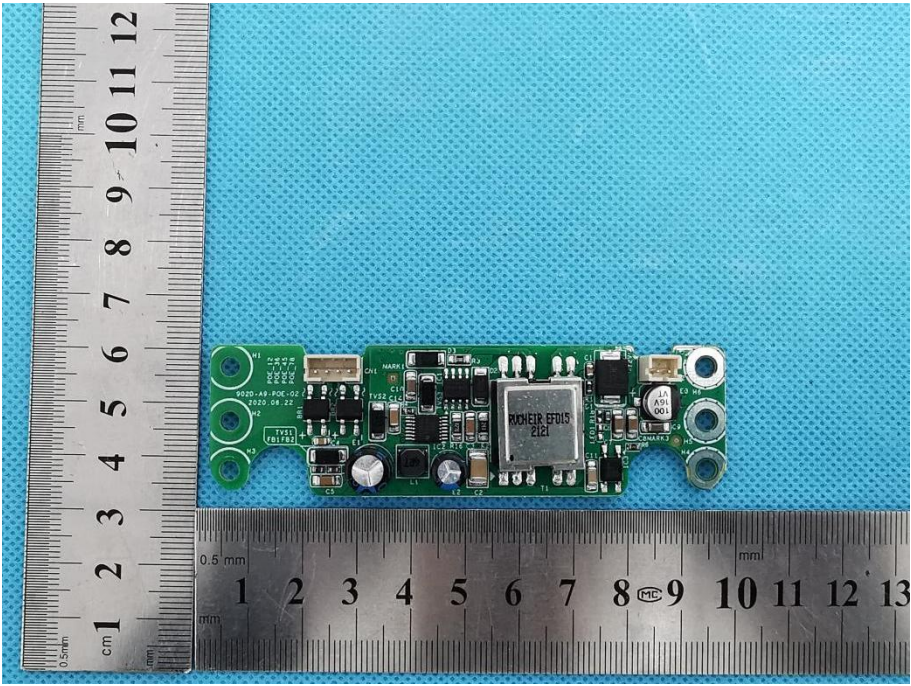


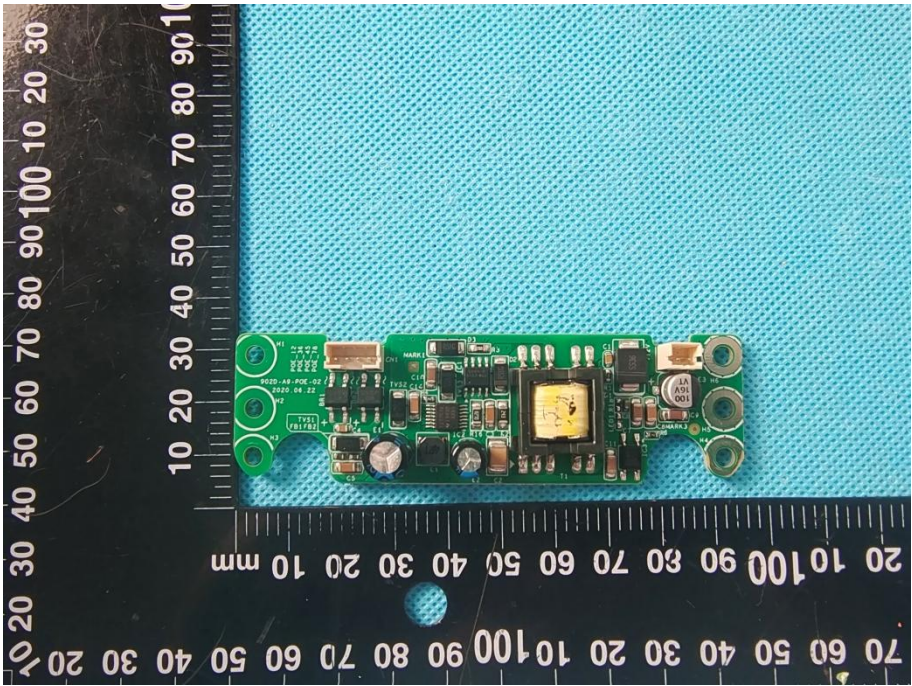
Solder
Board-Component View
12



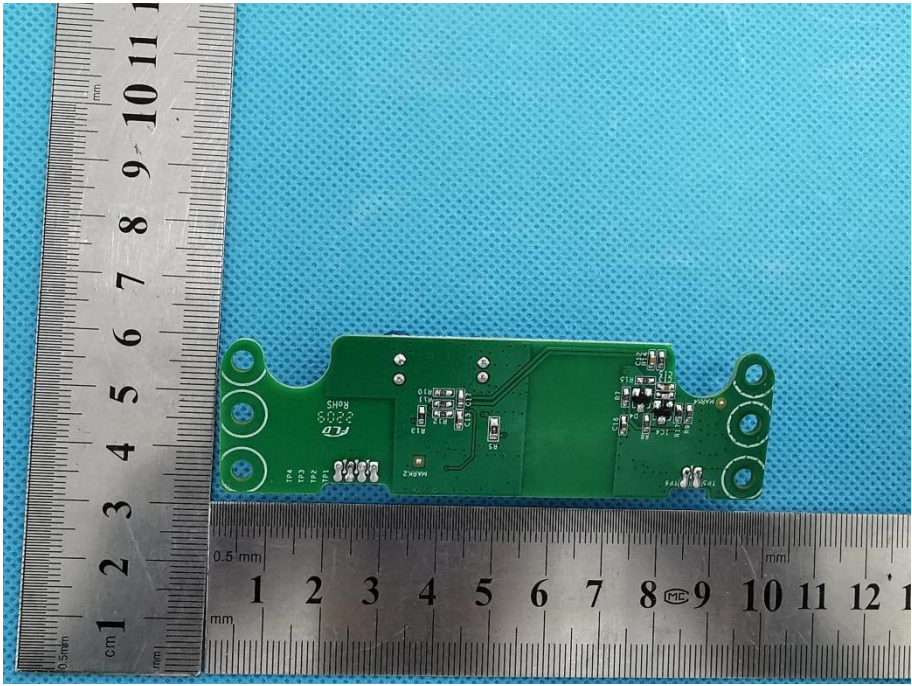
Solder
Board-Component View
13

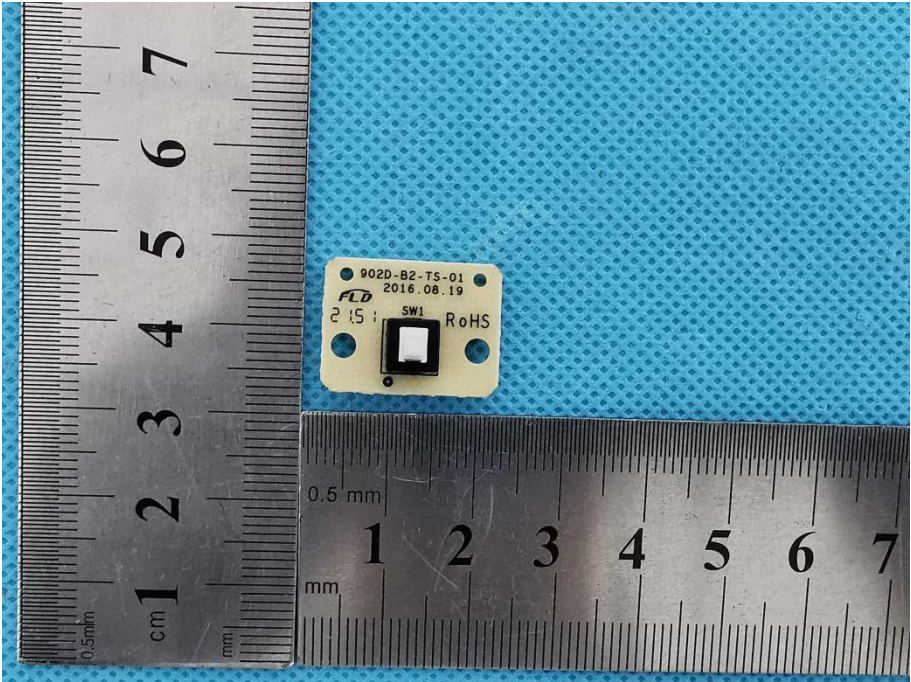
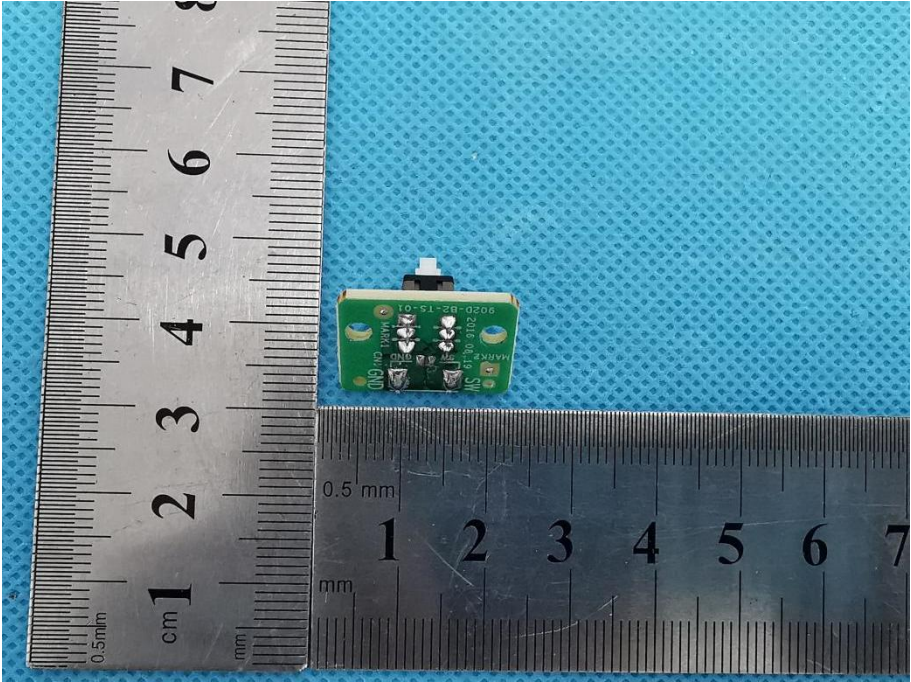


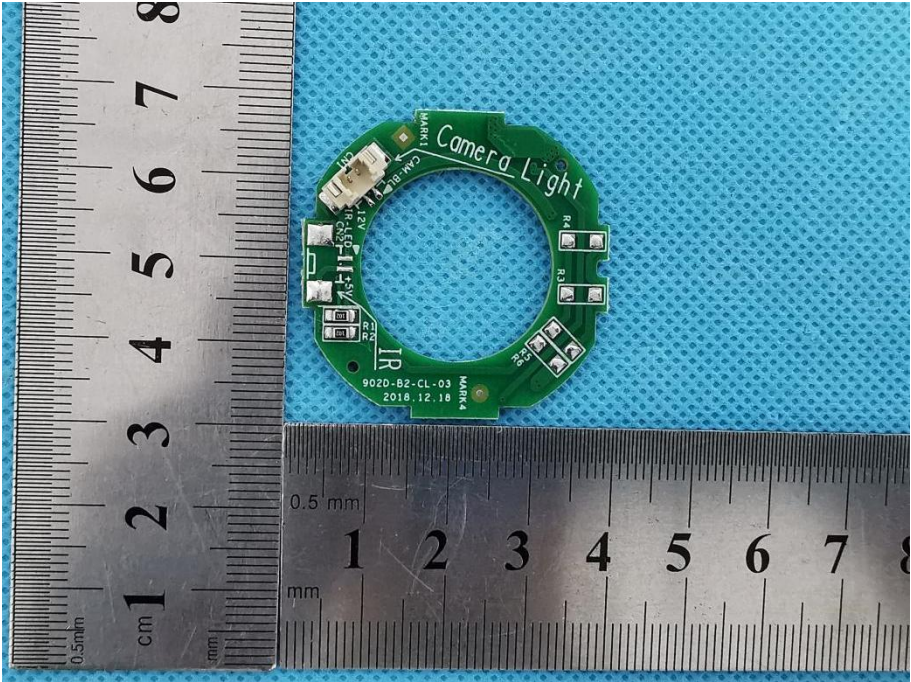
Solder
Board-Component View
14



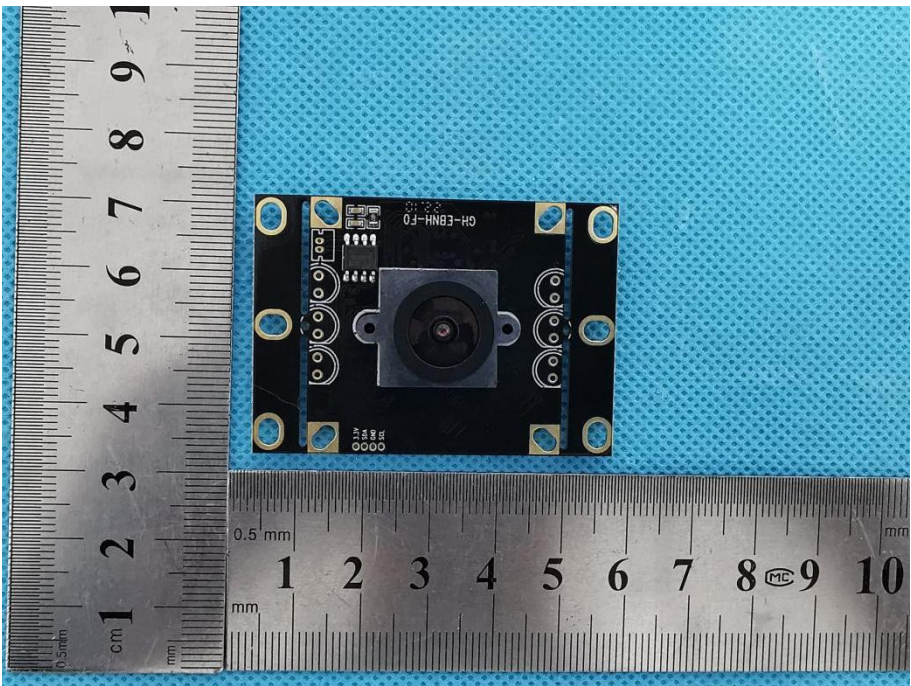
Solder
Board-Component View
15



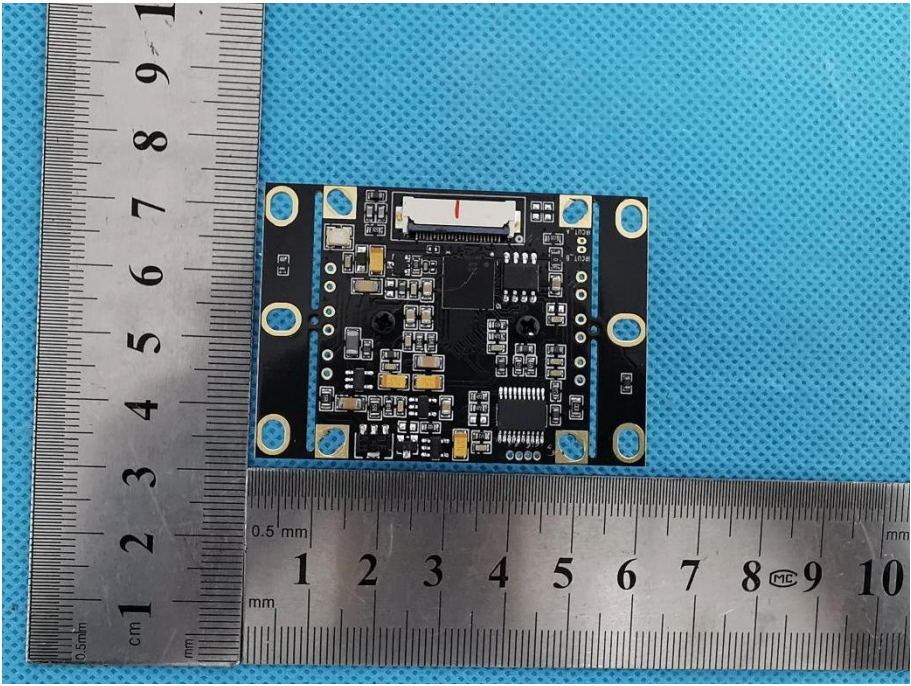
Solder Board-Component View 16	 A photograph of a small, yellow, rectangular component with a central square opening, mounted on a blue textured surface. The component is labeled with '902D-B2-TS-01', '2016.08.19', 'FID', '2 IS', 'SW1', and 'RoHS'. A metal ruler with millimeter markings is placed vertically to the left of the component for scale.
Solder Board-Component View 17	 A photograph of a small, green, rectangular component with various electronic components and a central square opening, mounted on a blue textured surface. The component is labeled with '902D-B2-TS-01', '2016.08.19', 'FID', '2 IS', 'SW1', and 'RoHS'. A metal ruler with millimeter markings is placed vertically to the left of the component for scale.

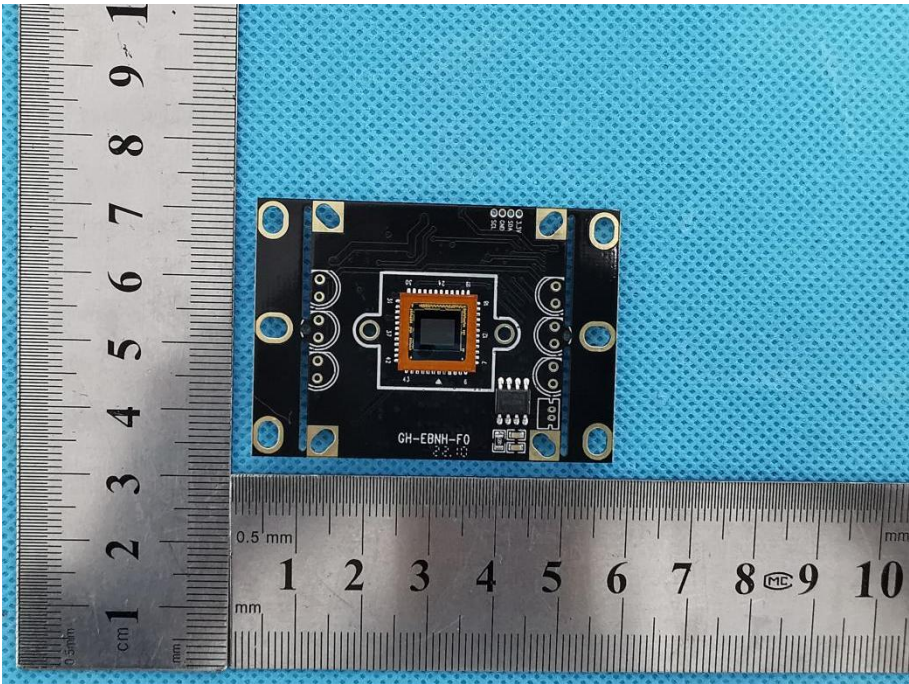
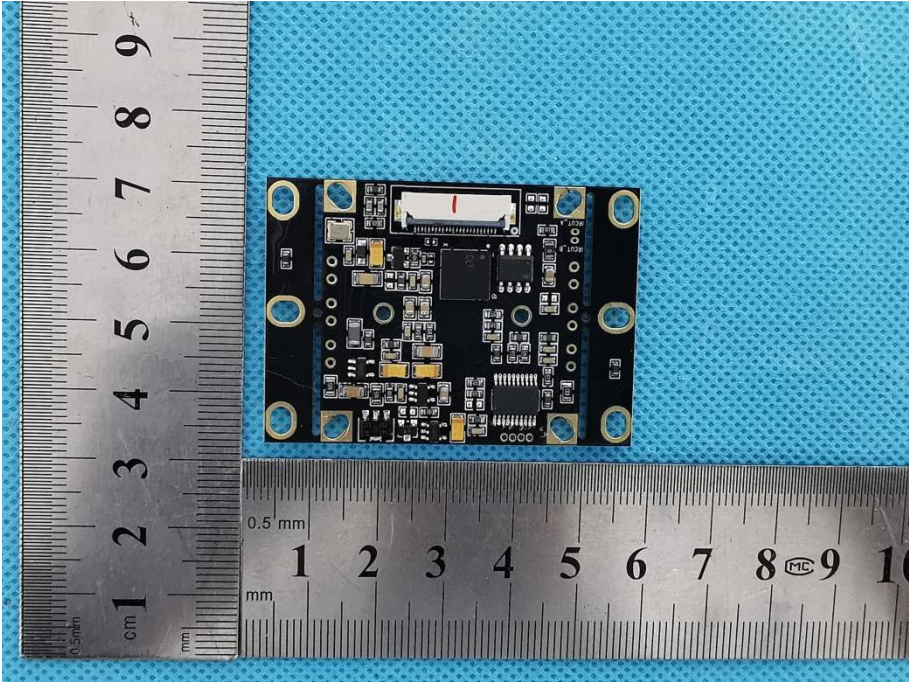
Solder Board-Component View 18	 A photograph of a circular green printed circuit board (PCB) component, labeled "Camera Light", placed on a blue textured surface. The component features a central circular cutout and is surrounded by various electronic components, including resistors and capacitors. It is positioned next to a metal ruler with millimeter markings for scale. The ruler shows the component is approximately 2.5 cm in diameter. The PCB has "MARK1" and "MARK4" labels, and the text "9020-B2-CL-03" and "2018.12.18" is visible.
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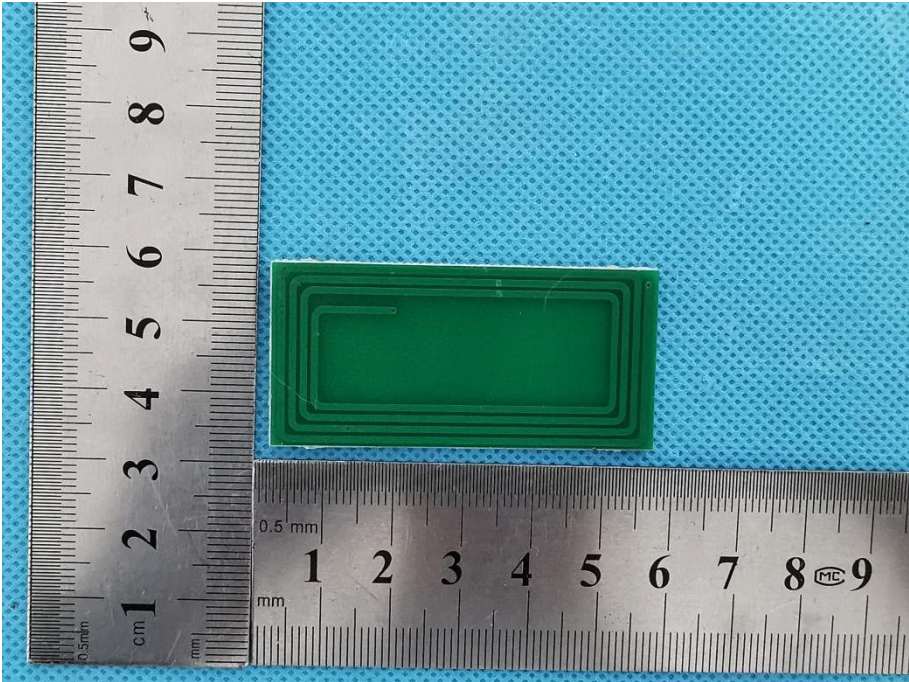
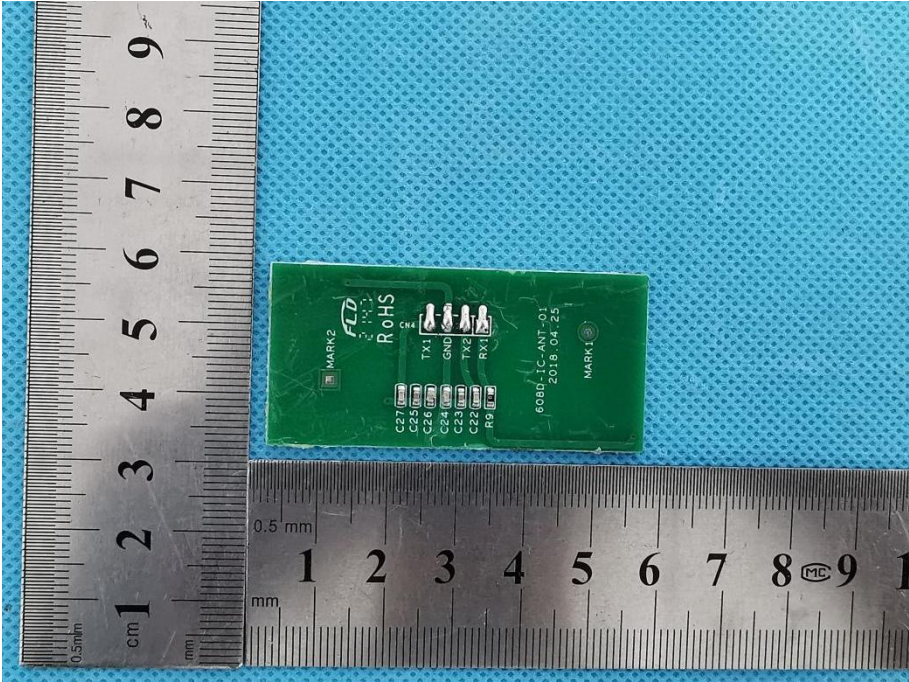
Solder
Board-Component View
20



Solder
Board-Component View
21



Solder Board-Component View 22	 A photograph of a small, square, black printed circuit board (PCB) component. The board is centered on a blue, textured background. It features a central square chip with a gold-colored pad, surrounded by a network of fine gold-colored traces. There are four circular gold-colored pads at the corners of the board. A metal ruler is placed horizontally below the board, showing a scale from 1 to 10 mm. A vertical ruler is placed to the left of the board, showing a scale from 1 to 10 cm. The component is labeled "GH-EBNH-F0" and "C 2.2 10" at the bottom.
Solder Board-Component View 23	 A photograph of a small, square, black printed circuit board (PCB) component, similar to the one in View 22. It is centered on a blue, textured background. The board features a central square chip with a gold-colored pad, surrounded by a network of fine gold-colored traces. There are four circular gold-colored pads at the corners of the board. A metal ruler is placed horizontally below the board, showing a scale from 1 to 10 mm. A vertical ruler is placed to the left of the board, showing a scale from 1 to 10 cm. The component is labeled "GH-EBNH-F0" and "C 2.2 10" at the bottom.

Solder Board-Component View 24	 A photograph showing a green rectangular component with a concentric square pattern on its surface. The component is placed on a blue textured background. A metal ruler is positioned vertically to the left and horizontally below the component, showing measurements in centimeters and millimeters. The horizontal ruler indicates the component is approximately 6 mm wide.
Solder Board-Component View 25	 A photograph showing a green rectangular component with various electronic components and markings. The component is placed on a blue textured background. A metal ruler is positioned vertically to the left and horizontally below the component, showing measurements in centimeters and millimeters. The horizontal ruler indicates the component is approximately 6 mm wide. Markings on the component include "FCD", "RoHS", "MARK2", "TX1", "GND", "TX2", "RX1", "R9", "C27", "C25", "C24", "C23", "C22", "POB0-IC-ANT-01", "2018.04.25", and "MARK1".

